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Issue Batch No.: L72
Allowed: 11/19/1998
S.N.: 08/756,830

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: Beaman et al.

Date: May 29, 2002

Serial No.: 08/756,830

Group Art Unit: 2858

Filed: November 20, 1996

Examiner: V. Nguyen

For: A HIGH DENSITY INTEGRAL TEST PROBE AND FABRICATION METHOD

Assistant Commissioner for Patents
Washington, D. C. 20231

SUBMISSION OF FORMAL DRAWINGS

Sir:

Enclosed herewith are seven (7) sheets of formal drawings (FIGS. 1-12) for the above-identified application, Serial No. 08/756,830 which has a Notice of Allowance date of November 19, 1998, and Issue Batch Number L72.

Respectfully submitted,

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IBM Docket Number: YO995-023XX

NO NOA date.